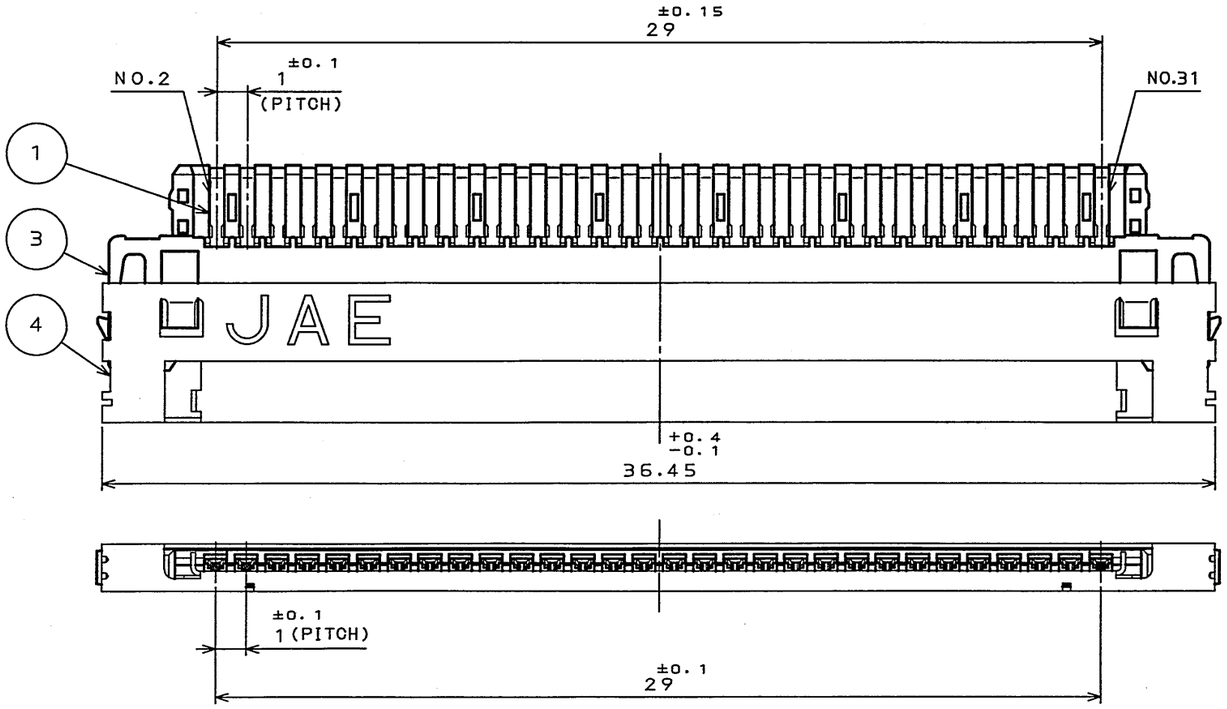
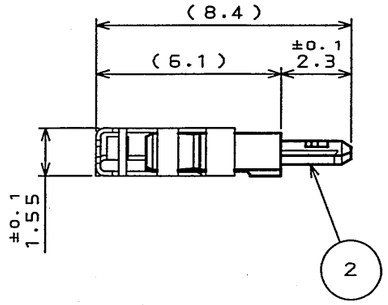
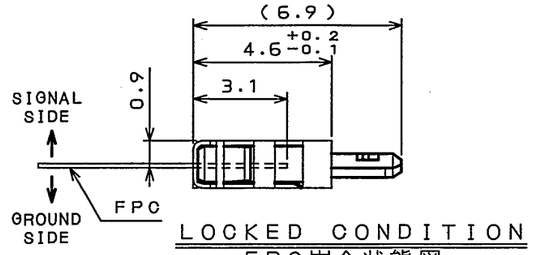
図面番号(DRAWING NO.) SJ100650

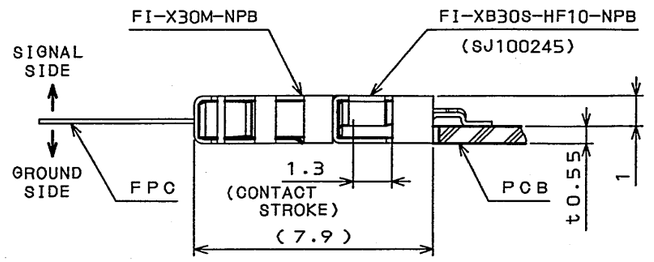
版数 REV.	年月日 DATE	DCN NO.	変更内容 DESCRIPTION	製図 DR.	担当 CHK.	査閲 APPD.	承認 APPD.

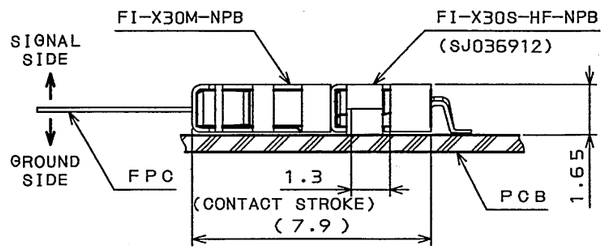




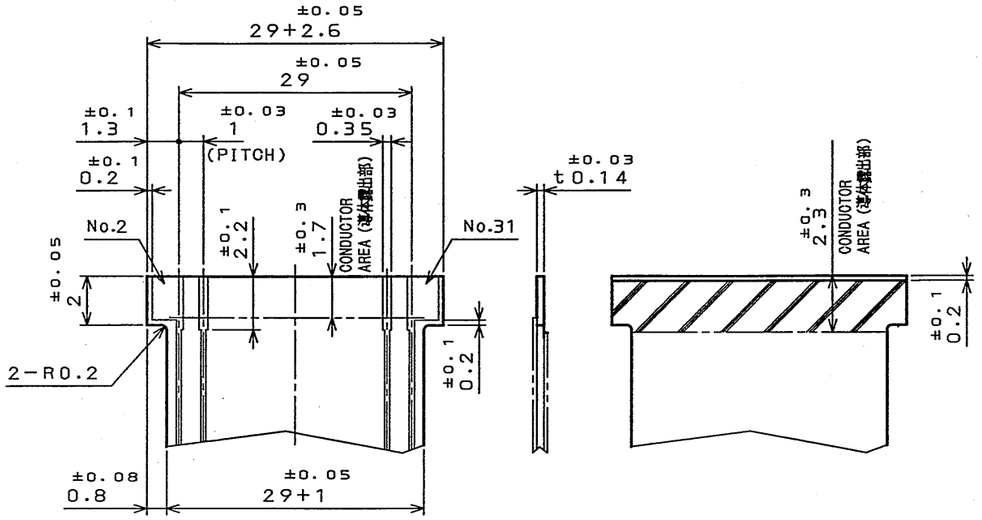


LOCKED CONDITION
FPC嵌合状態図





MATED CONDITION(REF.)
嵌合状態図(参考)



SIGNAL AREA
(信号側)

GROUND AREA
(グランド側)

APPLICABLE FPC. DIMENSIONS(REF.)
適合FPC寸法(参考)

符号 NO.	名称 DESCRIPTION	個数 QTY.	材料 MATERIAL	仕上 FINISH	備考 REMARKS
4	SHELL	1	COPPER ALLOY	TIN PLATING	———
3	INSULATOR	1	GLASS FILLED 4-6Ny	———	UL94 V-0 BEIGE
2	GROUND PLATE	1	COPPER ALLOY	TIN PLATING	———
1	CONTACT	30	COPPER ALLOY	GOLD(0.1μmMIN) OVER NICKEL	MATING FPC AREA: (LEAD FREE)TIN/TIN ALLOY OVER NICKEL

仕様書(SPECIFICATION)

第1版(ORIGINAL DATE) 28.Jan.2004

製図 DR.	H.SAKURADA
担当 CHK.	T.YAMAJI
査閲 APPD.	M. Suzuki
承認 APPD.	Y. Ishizawa

一般公差(GENERAL TOLERANCE)

寸法(DIMENSION)	角度(ANGLES)
. ±0.8	X° ±
.X ±0.4	X°X' ±
.XX ±0.1	
.XXX ±	

尺度(SCALE) 5:1

シリーズ(SERIES) FI-X

名称(TITLE) FI-X30M-NPB (FPC SIDE)

重量(WEIGHT)

日本航空電子工業株式会社
JAPAN AVIATION ELECTRONICS INDUSTRY, LTD.

図面番号(DRAWING NO.) SJ100650

版数(REV.) 1

SIZE A3

JAE-CONNECTOR.COM
Reference Only

LEAD FREE この製品は鉛フリー品です

JAE CONNECTOR DIV. PROPRIETARY.
COPYRIGHT(C) 2004, JAPAN AVIATION ELECTRONICS INDUSTRY, LTD.

DOF-O-212E(03.08)